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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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### Description

The 4925–4926 SAC305 RA Solder Wire is an electronic grade, lead-free solder wire. It uses the predominant lead-free alloy composition and exceeds J-STD-006C and meets ASTM B 32 purity specifications. It is complemented with a rosin activated, medium activity flux that is classified as ROM1 according to J-STD-004B. This solder is a great alternative to leaded solders.

The 4925–4926 non-leaded solder series achieve a consistent solder and flux percentage through a state-of-the-art, extrusion, wire-drawing machine. This machine continually monitors the wire to prevent voids and ensure consistency, providing a top-grade solder wire.

### Benefits & Features

- **Lead free & rosin activated flux**
- **Alloy exceeds J-STD-006C and meets ASTM B 32 purity requirements**
- **Flux meets J-STD-004B**
- **Fast wetting**
- **Fast flowing**
- **Non-corrosive**
- **Non-conductive residue**

#### COMPLIANCE

- ✓ Dobb-Frank ([DRC conflict free](#))
- ✓ REACH ([compliant](#))
- ✓ RoHS ([compliant](#))

### Wire Sizes Availability

<i>Cat No.</i>	<i>Std. Wire Gauge</i>	<i>Diameter</i>		<i>Packaging</i>	<i>Sizes</i>
4925	21	0.81 mm	0.032 in	Spool	¼ or 1 lb
4926	19	1.02 mm	0.040 in	Spool	¼ or 1 lb

### General Flux Parameters

<i>Properties</i>	<i>Value</i>
Residue Removal	Not required
Flux Percentage	2.2%
Flux Feature	Fast wetting, fast flowing, non-conductive
Shelf Life	5 y

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# SAC305 RA Solder Wire

## 4925–4926 Technical Data Sheet

ISO 9001:2008 Registered Quality System. Burlington, Ontario, CANADA SAI Global File: 004008

4925–4926

### Flux Core Properties

The rosin activated flux wets rapidly and is fast flowing. It is also non-conductive and non-corrosive.

<b>Physical Properties</b>	<b>Method</b>	<b>Value</b>
Flux Classification	J-STD-004B MIL-F-14256F	ROM1 RA
Flux Type		Rosin
%Halides		0.5–2.0%
Color	—	Amber solid
Softening Point of Flux Extract		80 °C [176 °F]
Acid Number (mgKOH/g sample)	IPC-TM-650 2.3.13	150–160
Silver Chromate—Chlorides + Bromides	IPC-TM-650 2.3.33	Detection
Surface Insulation Resistance (SIR)	IPC-TM-650 2.6.3.3	$>1.0 \times 10^9 \Omega$
Corrosion Test	IPC-TM-650 2.6.15	Non-corrosive
Cleaning Requirements	—	Application dependent <sup>a)</sup>

a) Since there is only 2.2% flux, removal of residue can be considered optional for some applications.

### SAC305 Alloy Typical Literature Properties

<b>Physical Properties</b>	<b>Value</b> <sup>a)</sup>
Color	Silvery-white metal
Density @26 °C [78 °F]	7.49 g/cm <sup>3</sup>
Tensile Strength	29.7 N/mm <sup>2</sup> [4 310 lb/in <sup>2</sup> ]
Tensile Yield	25.7 N/mm <sup>2</sup> [3 720 lb/in <sup>2</sup> ]
Elongation	27%
Shear Strength @20 °C and 0.1 mm/min	27 N/mm <sup>2</sup> [3 900 lb/in <sup>2</sup> ]
@100 °C and 0.1 mm/min	17 N/mm <sup>2</sup> [2 500 lb/in <sup>2</sup> ]
Creep Strength @20 °C and 0.1 mm/min	13 N/mm <sup>2</sup> [1 900 lb/in <sup>2</sup> ]
@100 °C and 0.1 mm/min	5.0 N/mm <sup>2</sup> [730 lb/in <sup>2</sup> ]
Hardness	15 HB

<b>Electric Properties</b>	<b>Value</b>
Volume Resistivity	13 $\mu\Omega$ ·cm
Electrical Conductivity <sup>b)</sup>	16.6% IACS

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<b>Thermal Properties</b>	<b>Value</b>
Melting Point, Solidus	217 °C [423 °F]
Melting Point, Liquidus	221 °C [430 °F]
Tip Temperature Upper Limit	Do not exceed 350 °C [662 °F]
Coefficient of Thermal Expansion (CTE) <sup>c)</sup>	23.5 ppm/°C
Thermal Conductivity	58.7 W/(m·K)


**NOTE:** This table present typical literature values for SAC305 alloys.

a) N/mm<sup>2</sup> = mPa; lb/in<sup>2</sup> = psi;

b) International Annealed Copper Standard: 100% give  $5.8 \times 10^7$  S/m.

c) CTE unit conversions: ppm/°C =  $\mu\text{m}/(\text{m}\cdot\text{K}) = \text{in}/\text{in}/\text{°C} \times 10^{-6} = \text{unit}/\text{unit}/\text{°C} \times 10^{-6}$

### Solder Alloy Composition

<b>Properties</b>	<b>Value</b>	<b>Properties</b>	<b>J-STD-006C</b>	<b>4925–4926</b>
<i>MAIN INGREDIENTS</i>		<i>IMPURITIES</i> <sup>a)</sup>	<i>REQUIREMENTS</i>	<i>SPECIFICATIONS</i>
Sn	96.2 to 96.8%	Sb	≤0.20% Max	≤0.05% Max
Ag	2.8 to 3.2%	Bi	≤0.10% Max	≤0.05% Max
Cu	0.4 to 0.6%	In	≤0.10% Max	≤0.05% Max
		Pb	≤0.07% Max	≤0.05% Max
		Au	≤0.05% Max	≤0.002% Max
		As	≤0.03% Max	≤0.01% Max
		Fe	≤0.02% Max	≤0.01% Max
		Ni	≤0.01% Max	≤0.005% Max
		Al	≤0.005% Max	≤0.001% Max
		Zn	≤0.003% Max	≤0.001% Max
		Cd	≤0.002% Max	≤0.001% Max

a) Exceeds the requirements of J-STD-006C and meets ASTM B 32.

### Storage

Protect from direct heat or sunlight. Store between 18 to 27 °C [65 to 80 °F].

### Cleaning

The flux residue does not need to be removed for typical applications. If removal is desired, a solvent system like the *MG 4140* can be used. For best results, warm the cleaning solution to about 40 °C [104 °F].

### Health and Safety

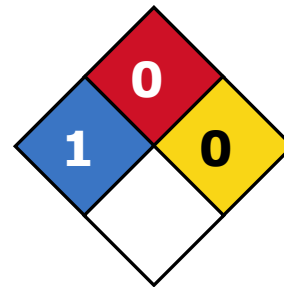
Please see the 4925x (where x = 5, 6) **Safety Data Sheet** (SDS) for more details on transportation, storage, handling and other security guidelines.

**Health and Safety:** Avoid breathing fumes. Wash hands thoroughly after use. Do not ingest.

#### HMIS® RATING

<b>HEALTH:</b>	<b>* 1</b>
<b>FLAMMABILITY:</b>	<b>0</b>
<b>PHYSICAL HAZARD:</b>	<b>0</b>
<b>PERSONAL PROTECTION:</b>	

#### NFPA® 704 CODES



*Approximate HMIS and NFPA Risk Ratings Legend:*

0 (Low or none); 1 (Slight); 2 (Moderate); 3 (Serious); 4 (Severe)

### Packaging and Supporting Products

<i>Cat. No.</i>	<i>Form</i>	<i>Package</i>	<i>Net Weight</i>	
<b>4925-112G</b>	Solid wire	Spool	113 g	0.25 lb
<b>4925-454G</b>	Solid wire	Spool	454 g	1.0 lb
<b>4926-112G</b>	Solid wire	Spool	113 g	0.25 lb
<b>4926-454G</b>	Solid wire	Spool	454 g	1.0 lb

a) Box of 25 pocket packs



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4925–4926

## Technical Support

Contact us regarding any questions, improvement suggestions, or problems with this product. Application notes, instructions, and FAQs are located at [www.mgchemicals.com](http://www.mgchemicals.com).

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## Warranty

*M.G. Chemicals Ltd.* warrants this product for 12 months from the date of purchase by the end user. *M.G. Chemicals Ltd.* makes no claims as to shelf life of this product for the warranty. The liability of *M.G. Chemicals Ltd.* whether based on its warranty, contracts, or otherwise shall in no case include incidental or consequential damage.

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